# 2SD1705

### Silicon NPN epitaxial planar type

For power switching

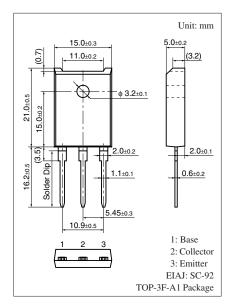
Complementary to 2SB1154

#### Features

- $\bullet$  Low collector-emitter saturation voltage  $V_{\mbox{CE(sat)}}$
- $\bullet$  Satisfactory linearity of forward current transfer ratio  $h_{\text{FE}}$
- Large collector current I<sub>C</sub>
- Full-pack package which can be installed to the heat sink with one screw

#### Absolute Maximum Ratings $T_C = 25^{\circ}C$

Parameter		Symbol	Rating	Unit		
Collector-base voltage (Emitter open)		V <sub>CBO</sub>	130	V		
Collector-emitter voltage (Base open)		V <sub>CEO</sub>	80	V		
Emitter-base voltage (Collector open)		V <sub>EBO</sub>	7	V		
Collector current		I <sub>C</sub>	10	А		
Peak collector current	I <sub>CP</sub>	20	А			
Collector power dissipation		P <sub>C</sub>	70	W		
	$T_a = 25^{\circ}C$		3.0			
Junction temperature		Tj	150	°C		
Storage temperature		T <sub>stg</sub>	-55 to +150	°C		



#### Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

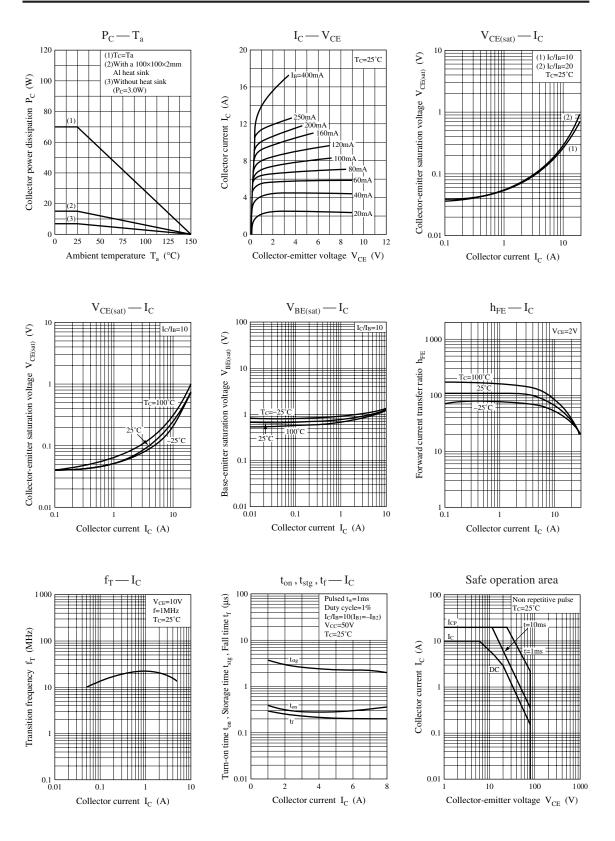
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{C} = 10 \text{ mA}, I_{B} = 0$	80			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 100 \text{ V}, I_E = 0$			10	μΑ
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	$V_{EB} = 5 V, I_C = 0$			50	μΑ
Forward current transfer ratio	h <sub>FE1</sub>	$V_{CE} = 2 V, I_C = 0.1 A$	45			_
	h <sub>FE2</sub> *	$V_{CE} = 2 V, I_C = 3 A$	90		260	
	h <sub>FE3</sub>	$V_{CE} = 2 V, I_C = 6 A$	30			
Collector-emitter saturation voltage	V <sub>CE(sat)1</sub>	$I_{\rm C} = 6 \text{ A}, I_{\rm B} = 0.3 \text{ A}$			0.5	V
	V <sub>CE(sat)2</sub>	$I_{\rm C} = 10 \text{ A}, I_{\rm B} = 1 \text{ A}$			1.5	
Base-emitter saturation voltage	V <sub>BE(sat)1</sub>	$I_{\rm C} = 6 \text{ A}, I_{\rm B} = 0.3 \text{ A}$			1.5	V
	V <sub>BE(sat)2</sub>	$I_{C} = 10 \text{ A}, I_{B} = 1 \text{ A}$			2.5	
Transition frequency	f <sub>T</sub>	$V_{CE} = 10 \text{ V}, I_C = 0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Turn-on time	t <sub>on</sub>	$I_{C} = 6 A, I_{B1} = 0.6 A, I_{B2} = -0.6 A$		0.5		μs
Storage time	t <sub>stg</sub>	$V_{CC} = 50 V$		2.0		μs
Fall time	t <sub>f</sub>			0.2		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

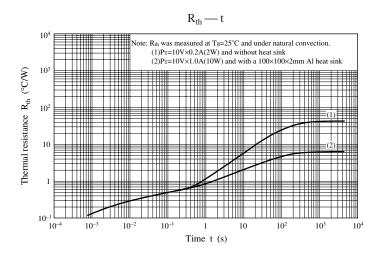
2. \*: Rank classification

Rank	Q	Р		
h <sub>FE2</sub>	90 to 180	130 to 260		

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